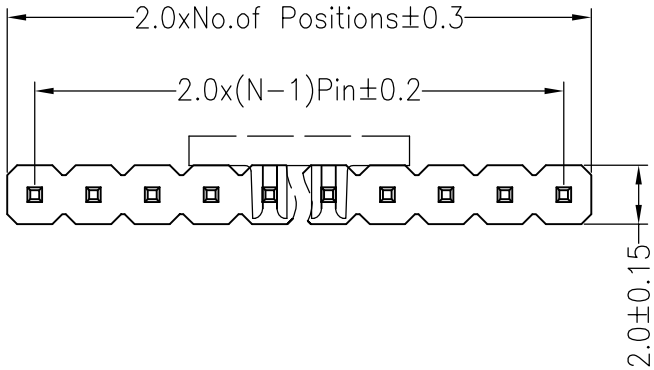
HSF RoHS

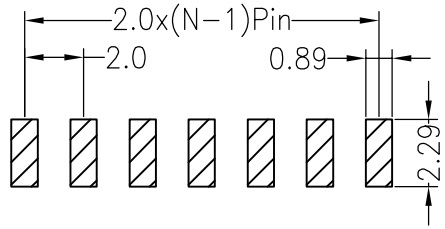
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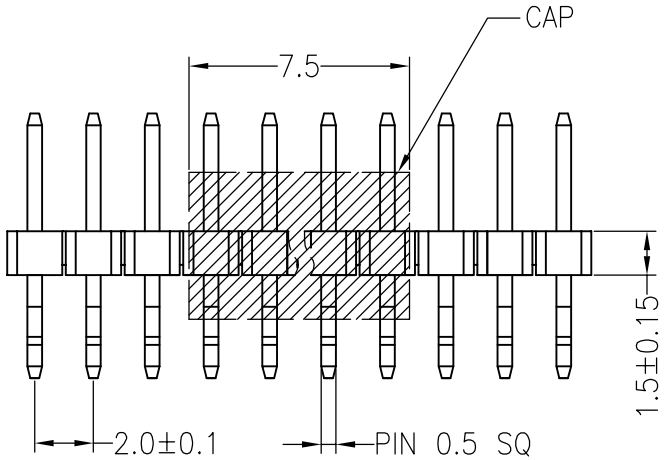
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

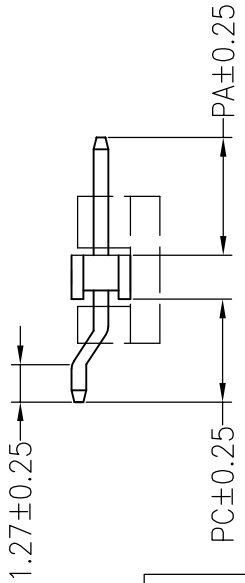
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1315 11 XX X N XX Z XXX X 01

No.of Pins Per Row	Insulator Material Option	Contact Plating	Pin Length	Packing
1x40 2x40 1−−40 2−−80	A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin		0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap

Dimension antitheses list			
ITEM	PA	PC	L
Standard	4.00	2.80	8.50
Alternate			

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.11	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.04.11	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	131511XXXNXXZXXXX01
TITLE:	2.0PH 1xnPin H1.5 90° SMT